TOSHIBA Photocoupler PHOTORELAY

TLP3220

Memory Tester Logic Tester Measurement Instrument

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The TOSHIBA TLP3220 is a super small-outline photorelay, suitable for surface-mount assembly. The TLP3220 consists of an infrared emitting diode optically coupled to a photo-MOS FET and housed in a 4-pin package.

Features

- 4 pin SSOP (SSOP4)
- 1-Form-A
- Peak off-state voltage
- Trigger LED current
- On-state current
- On-state resistance
- Output capacitance
- Isolation voltage
- UL-recognized

1

2 **C**

Schematic

1 °

2 0

: 80 mA (max) : 14 Ω (max), 8 Ω (typ.)

: 5 mA (max)

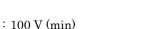
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- : 8 pF (max), 6 pF (typ.)
- : 1500 Vrms (min)
- : UL 1577, File No.E67349

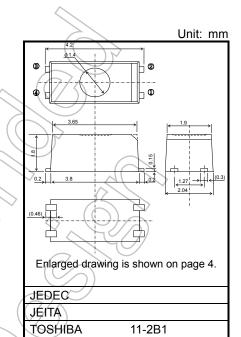
Pin configuration (top view)

1 : Anode 2 : Cathode 3 : Drain 4 : Drain



: 1.8 mm high, 1.27 mm pitch





Weight: 0.03 g (typ.)

Absolute Maximum Ratings (Ta = 25°C)

| | Characteristic | Symbol | Rating | Unit | |
|----------|---|---------------------|------------|---------|------------|
| LED | Forward current | lF | 50 | mA | |
| | Forward current derating (Ta≥25°C) | ∆IF/°C | -0.5 | mA/°C | |
| | Reverse voltage | VR | 5 | V _ | |
| | Diode power dissipation | PD | 50 | mW | |
| | Diode power dissipation derating (Ta >25°C) | ∆P _D /°C | -0.5 | mW/°C | \bigcirc |
| | Junction temperature | Tj | 125 | °C | |
| | Off-State output terminal voltage | Voff | 100 | ¥7/ | \sim |
| | On-State current | Ion | 80 | Am | <u>ک</u> |
| Detector | On-State current derating (Ta≥25°C) | ∆lon/°C | -0.8 | mA/°C | |
| Dete | Output power dissipation | Po | 96 | mVV | |
| | Output power dissipation derating (Ta \ge 25°C) | ΔP _o /°C | -0.96 | mW / °C | |
| | Junction temperature | Tj | 125 | °C | Δ |
| Stora | age temperature range | T _{stg} | -40 to 125 | °C | |
| Oper | ating temperature range | Topr | -20 to 85 | °C | |
| Lead | soldering temperature (10 s) | T _{sol} | 260 | °C | |
| Isola | tion voltage (AC, 60 s, R.H.≤ 60 %) (Note 1) | BVs | 1500 | Vrms | |

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(Note 1): Device considered a two-terminal device: Pins 1 and 2 shorted together, and pins 3 and 4 shorted together.

Precautions

This device is sensitive to electrostatic discharge. When using this device, please ensure that all tools and equipment are earthed.

Recommended Operating Conditions

| Characteristic | Symbol | Min | Тур. | Max | Unit |
|-----------------------|------------------|-----|------|-----|------|
| Supply voltage | VDD | _ | — | 80 | V |
| Forward current | IF | 10 | — | 30 | mA |
| Operating temperature | T _{opr} | 25 | | 60 | °C |

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Individual Electrical Characteristics (Ta = 25°C)

| | Characteristic | Symbol | Test Condition | Min | Тур. | Max | Unit |
|----------|------------------------|----------------|-------------------------------|-----|------|-----|------|
| | Forward voltage | VF | IF = 10 mA | 1.0 | 1.15 | 1.3 | V |
| LED | Reverse current | I _R | $V_R = 5 V$ | _ | _ | 10 | μA |
| | Capacitance | Ст | V = 0 V, f = 1 MHz | _ | 15 | _ | pF |
| Detector | Off-state current IOFF | loss | Voff = 80 V | _ | _ | 200 | pА |
| | | VOFF = 100 V | | | 1 | μA | |
| | Capacitance | COFF | V = 0 V, f = 100 MHz, t < 1 s | | 6 | 8 | pF |

Coupled Electrical Characteristics (Ta = 25°C)

| Characteristic | Symbol | Test Condition | Min | Тур. | Max | Unit |
|---------------------|-----------------|--|-----|------|-----|------|
| Trigger LED current | I _{FT} | I _{ON} = 80 mA | _ | 1 | 5 | mA |
| Return LED current | I _{FC} | $I_{OFF} = 1 \ \mu A$ | 0.2 | | - | mA |
| On-state resistance | R _{ON} | I_{ON} = 80 mA, I_F = 10 mA, t = 10 ms | X | 8 | 14 | Ω |

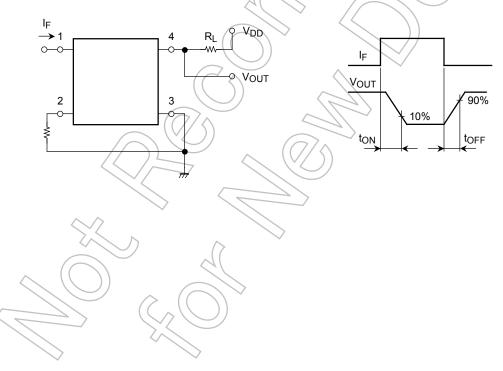
Isolation Characteristics (Ta = 25°C)

| Characteristic | Symbol | Test Condition | Min | Тур. | Max | Unit |
|-----------------------------|--------|------------------------------------|--------------------|--|-----|------|
| Capacitance input to output | Cs | Vs = 0 V, f = 1 MHz | 1 | 0.6 | _ | pF |
| Isolation resistance | Rs | V _S = 500 V, R.H.≤ 60 % | 5×10 ¹⁰ | 10 ¹⁴ | _ | Ω |
| Isolation voltage | BVs | AC, 60 s | 1500 | The second secon | 1 | Vrms |

Switching Characteristics (Ta = 25°C)

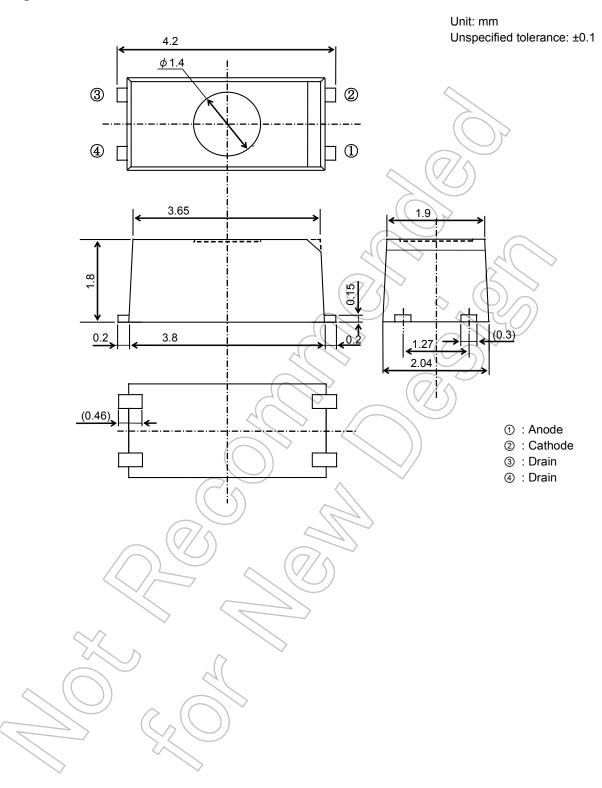
| vitching Characteristics (| (Ta = 25°C) | | | | |
|----------------------------|-------------|--|-------------|-------|------|
| Characteristic | Symbol | Test Condition | Min Typ | . Max | Unit |
| Turn-on time | ton | R _L = 200 Ω (N | Note 2) 100 | 0 300 | |
| Turn-off time | tOFF | $V_{DD} = 20 \text{ V}, \text{ IF} = 5 \text{ mA}$ | 100 | 0 300 | μS |

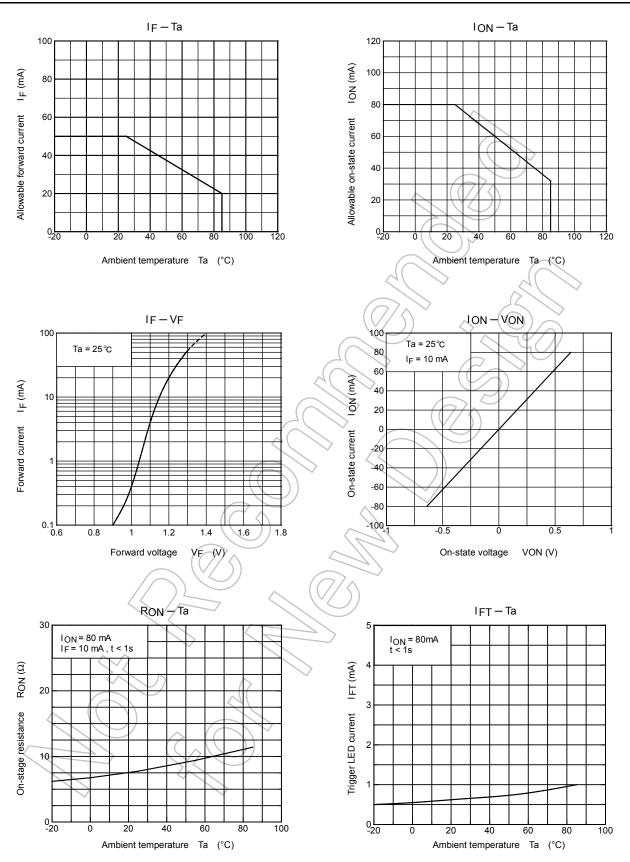
(Note 2): switching time test circuit



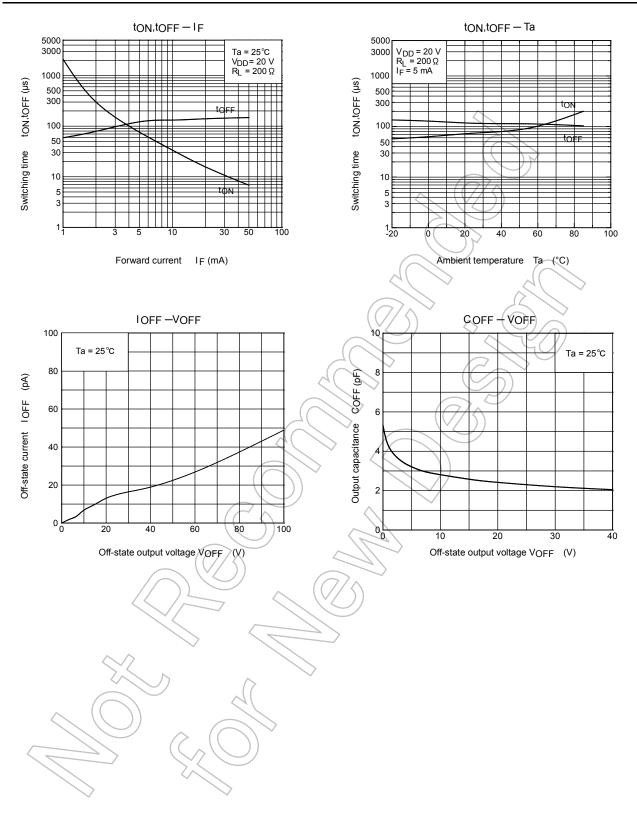
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Package Dimensions





NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



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